

N-Channel and P-Channel 20V(D-S) MOSFET

Product summary			
V_{DS}	20	-20	V
$R_{DS(ON)}$ (at $V_{GS}=4.5V$) Typ.	250	350	mΩ
$R_{DS(ON)}$ (at $V_{GS}=2.5V$) Typ.	300	440	mΩ
$I_D(T_A=25^{\circ}C)$	0.65	-0.55	A

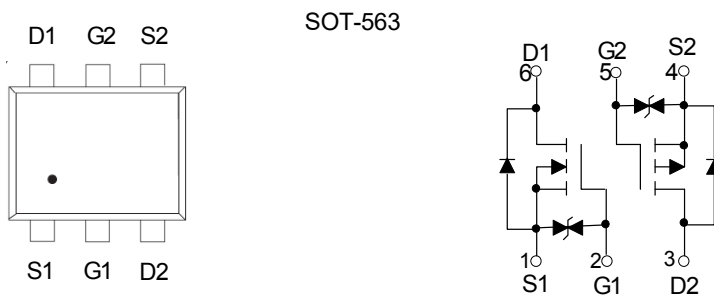
Features

- Low $R_{DS(ON)}$
- ESD Protected Gate

Applications

- Logic Level Shift
- Load switch

Pin Configuration



Packing Information

Device	Package	Reel Size	Quantity(Min. Package)
ECDJ1014E	SOT-563	7"	3000pcs

Absolute Maximum Ratings (at $T_A=25^{\circ}C$ Unless Otherwise Noted)

Symbol	Parameter	N-Rating	P-Rating	Units	
V_{DS}	Drain-Source Voltage	20	-20	V	
V_{GS}	Gate-Source Voltage	±10	±8	V	
I_D	Continuous Drain Current ^A	$T_A=25^{\circ}C$	0.65	-0.55	A
		$T_A=70^{\circ}C$	0.5	-0.45	A
I_{DM}	Pulse Drain Current Tested ^B	3	-2.8	A	
P_D	Power Dissipation ^A	0.15	0.15	W	
T_J, T_{STG}	Junction and Storage Temperature Range	-55 to +150	-55 to +150	°C	

Thermal Characteristics

Symbol	Parameter	Typical	Units
$R_{\theta JA}$	Thermal Resistance-Junction to ambient ^A	417	°C/W

N-Channel Electrical Characteristics (at $T_J = 25^\circ\text{C}$ Unless Otherwise Noted)

Symbol	Parameter	Condition	Min.	Typ.	Max.	Units
Static Parameters						
BV_{DSS}	Drain-Source Breakdown Voltage	$V_{GS}=0V, I_D=250\mu A$	20	--	--	V
I_{DSS}	Zero Gate Voltage Drain Current	$V_{DS}=16V, V_{GS}=0V$	--	--	1	μA
I_{GSS}	Gate-Body Leakage Current	$V_{DS}=0V, V_{GS}=\pm 10V$	--	--	± 30	μA
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS}=V_{GS}, I_D=250\mu A$	0.4	--	1.0	V
$R_{DS(ON)}$	Drain-Source On-State Resistance ^B	$V_{GS}=4.5V, I_D=0.5A$	--	250	380	m Ω
		$V_{GS}=2.5V, I_D=0.2A$	--	300	440	m Ω
		$V_{GS}=1.8V, I_D=0.1A$	--	370	530	m Ω
V_{SD}	Diode Forward Voltage	$I_S=0.5A, V_{GS}=0V$	--	--	1.2	V
Dynamic Parameters ^C						
C_{iss}	Input Capacitance	$V_{GS}=0V, V_{DS}=10V$ $f=1\text{MHz}$	--	67	--	pF
C_{oss}	Output Capacitance		--	18	--	pF
C_{rss}	Reverse Transfer Capacitance		--	6	--	pF
Q_g	Total Gate Charge	$V_{DS}=10V, I_D=0.5A$ $V_{GS}=4.5V$	--	1.4	--	nC
Q_{gs}	Gate-Source Charge		--	0.21	--	nC
Q_{gd}	Gate-Drain Charge		--	0.21	--	nC
$t_{D(on)}$	Turn-on Delay Time	$V_{DD}=10V$ $I_D=0.15A, R_G=10\Omega,$ $V_{GS}=4.5V$	--	2.8	--	ns
t_r	Turn-on Rise Time		--	20	--	ns
$t_{D(off)}$	Turn-off Delay Time		--	23	--	ns
t_f	Turn-off Fall Time		--	24	--	ns

A. The data tested by surface mounted on a 1 inch x 1 inch FR-4 board with 2OZ copper.

B. Pulse Test: Pulse Width $\leq 300\mu s$, Duty cycle $\leq 2\%$.

C. Guaranteed by design, not subject to production testing.

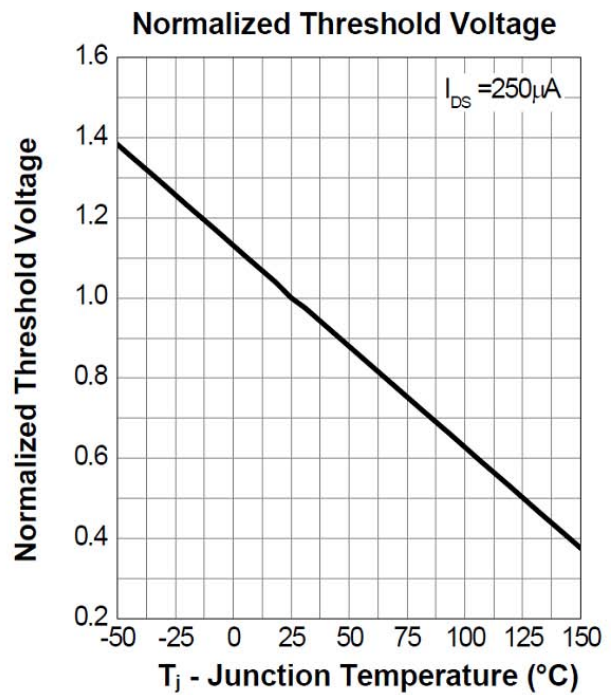
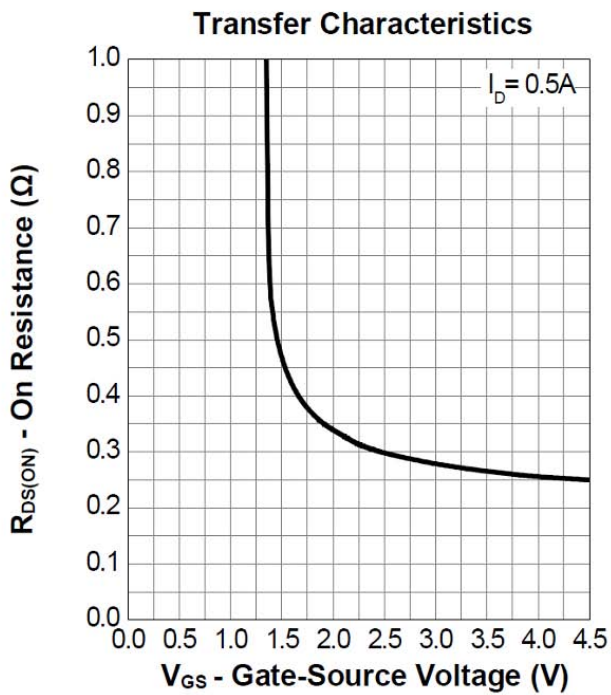
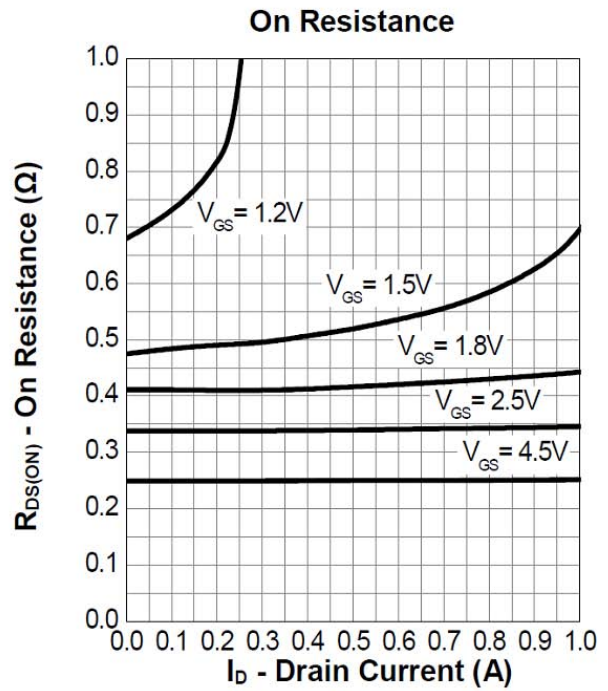
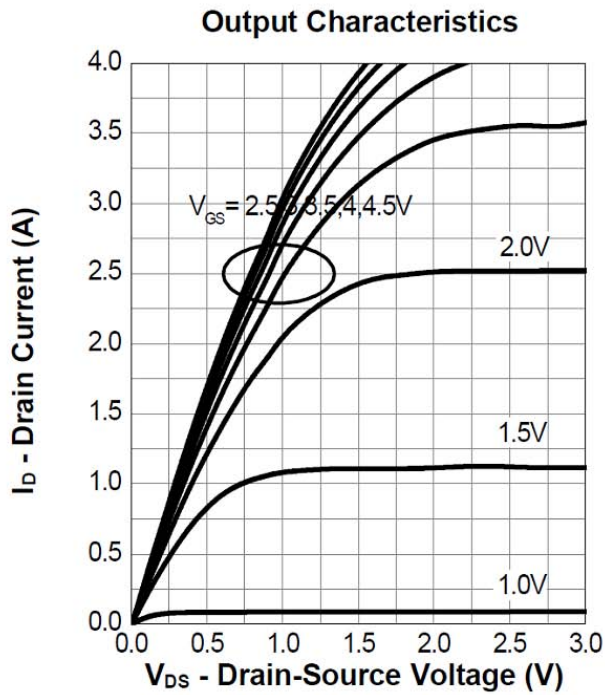
P-Channel Electrical Characteristics (at $T_J = 25^\circ\text{C}$ Unless Otherwise Noted)

Symbol	Parameter	Condition	Min.	Typ.	Max.	Units
Static Parameters						
BV_{DSS}	Drain-Source Breakdown Voltage	$V_{GS}=0V, I_D=-250\mu A$	-20	--	--	V
I_{DSS}	Zero Gate Voltage Drain Current	$V_{DS}=-16V, V_{GS}=0V$	--	--	-1	μA
I_{GSS}	Gate-Body Leakage Current	$V_{DS}=0V, V_{GS}=\pm 6V$	--	--	± 10	μA
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS}=V_{GS}, I_D=-250\mu A$	-0.45	--	-1.2	V
$R_{DS(ON)}$	Drain-Source On-State Resistance ^B	$V_{GS}=-4.5V, I_D=-0.5A$	--	350	480	m Ω
		$V_{GS}=-2.5V, I_D=-0.3A$	--	440	670	m Ω
		$V_{GS}=-1.8V, I_D=-0.1A$	--	780	--	m Ω
V_{SD}	Diode Forward Voltage	$I_S=-0.35A, V_{GS}=0V$	--	--	-1.2	V
Dynamic Parameters ^C						
C_{iss}	Input Capacitance	$V_{GS}=0V, V_{DS}=-16V$ $f=1\text{MHz}$	--	152	--	pF
C_{oss}	Output Capacitance		--	18	--	pF
C_{rss}	Reverse Transfer Capacitance		--	6	--	pF
Q_g	Total Gate Charge	$V_{DS}=-16V, I_D=-0.2A$ $V_{GS}=-4.5V$	--	2.8	--	nC
Q_{gs}	Gate-Source Charge		--	2.1	--	nC
Q_{gd}	Gate-Drain Charge		--	0.5	--	nC
$t_{D(on)}$	Turn-on Delay Time	$V_{DD}=-10V$ $I_D=-0.2A, R_G=10\Omega,$ $V_{GS}=-4.5V$	--	51.3	--	ns
t_r	Turn-on Rise Time		--	24.2	--	ns
$t_{D(off)}$	Turn-off Delay Time		--	246	--	ns
t_f	Turn-off Fall Time		--	81.2	--	ns

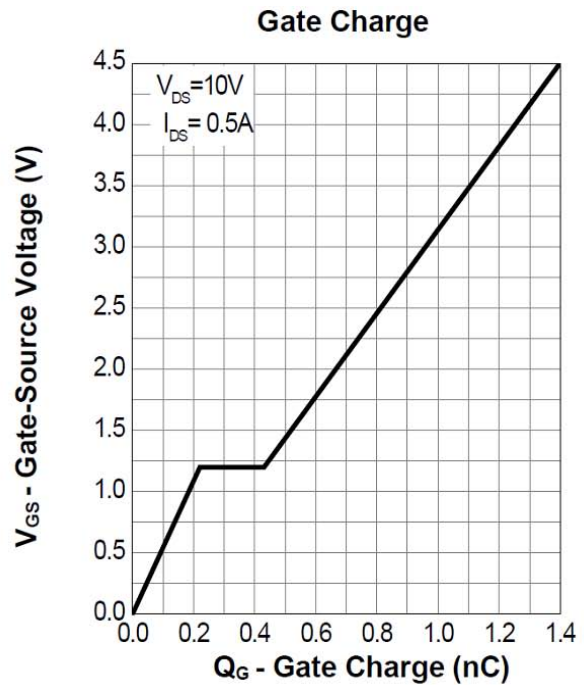
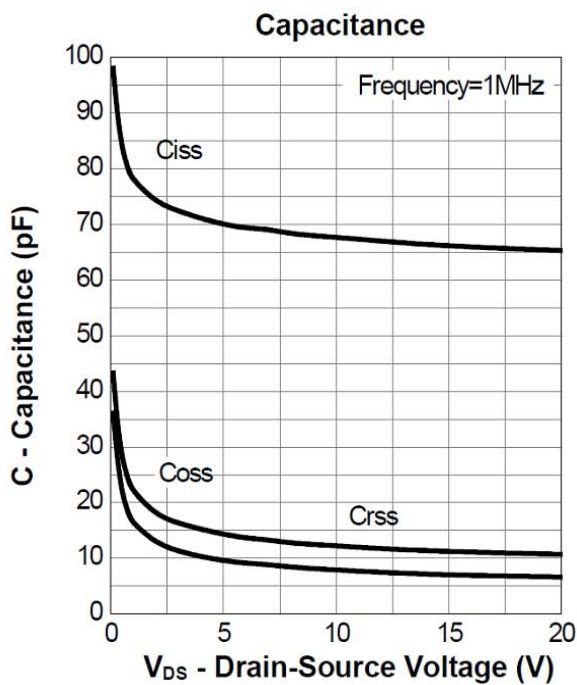
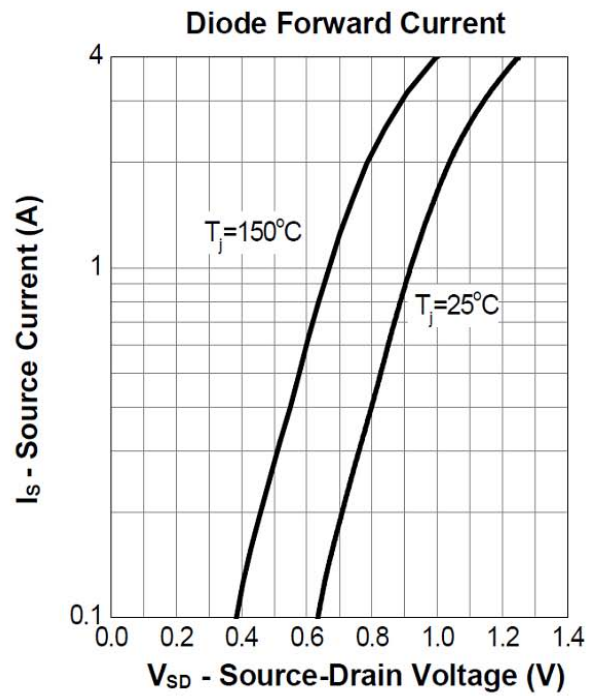
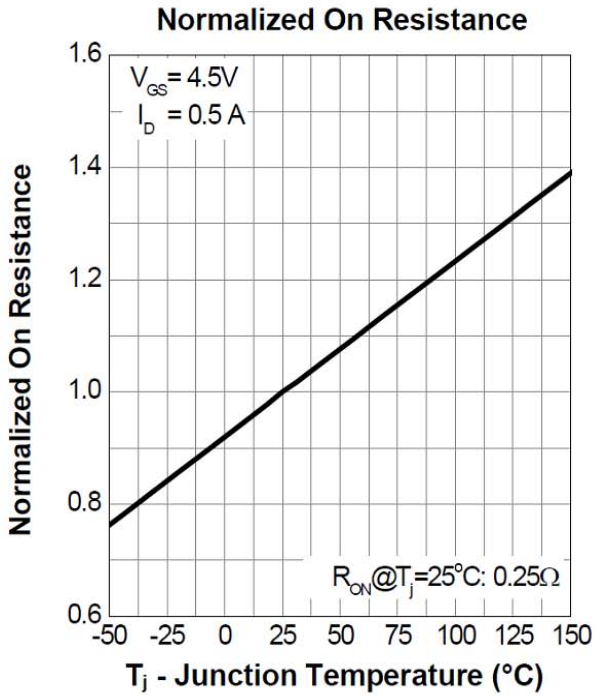
B. Pulse Test: Pulse Width $\leq 300\mu s$, Duty cycle $\leq 2\%$.

C. Guaranteed by design, not subject to production testing.

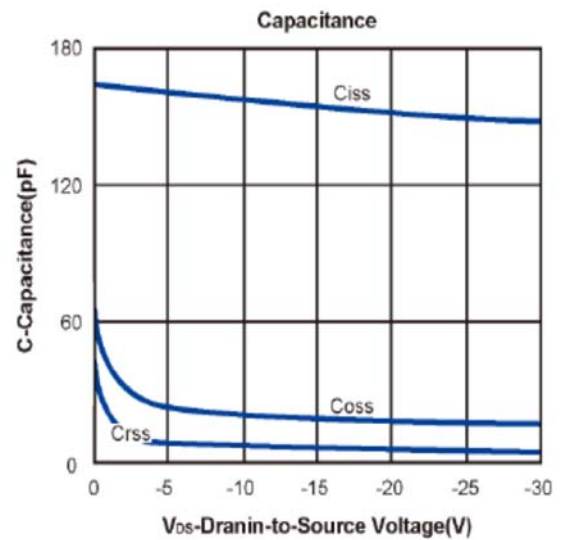
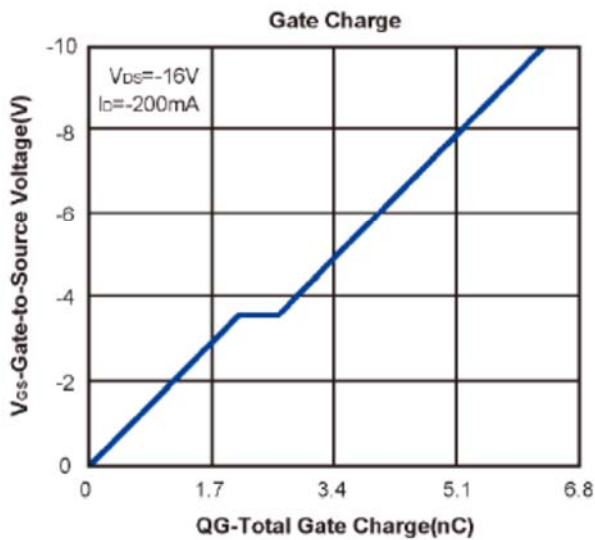
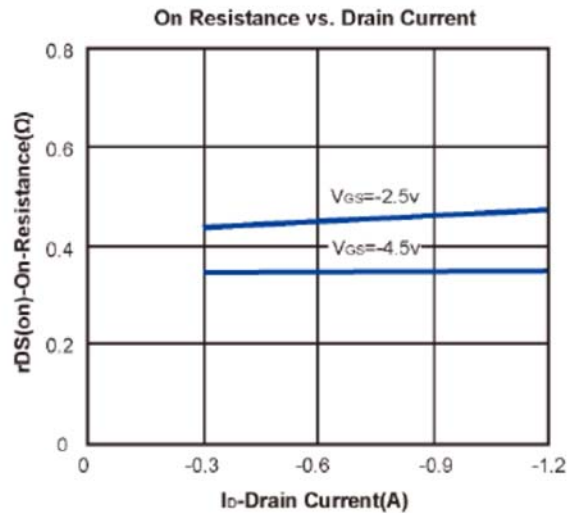
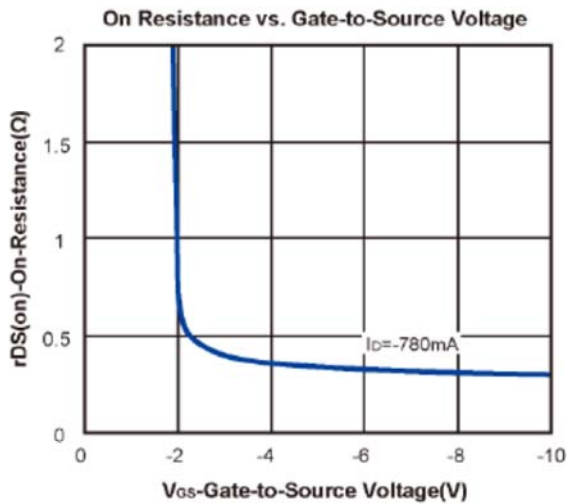
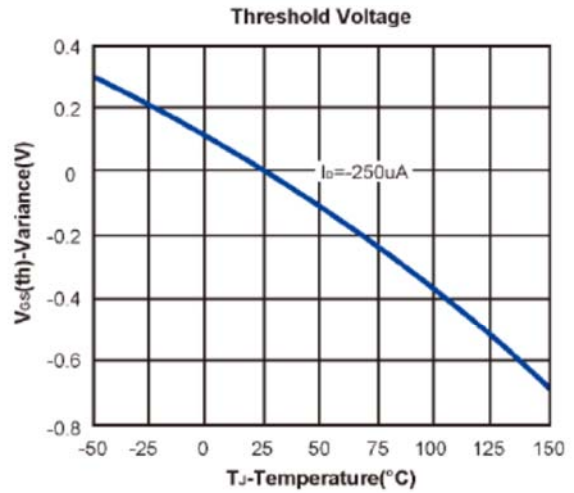
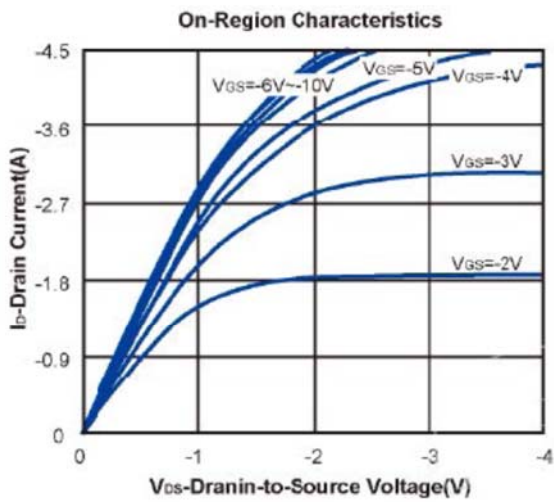
N-Channel Typical Characteristics



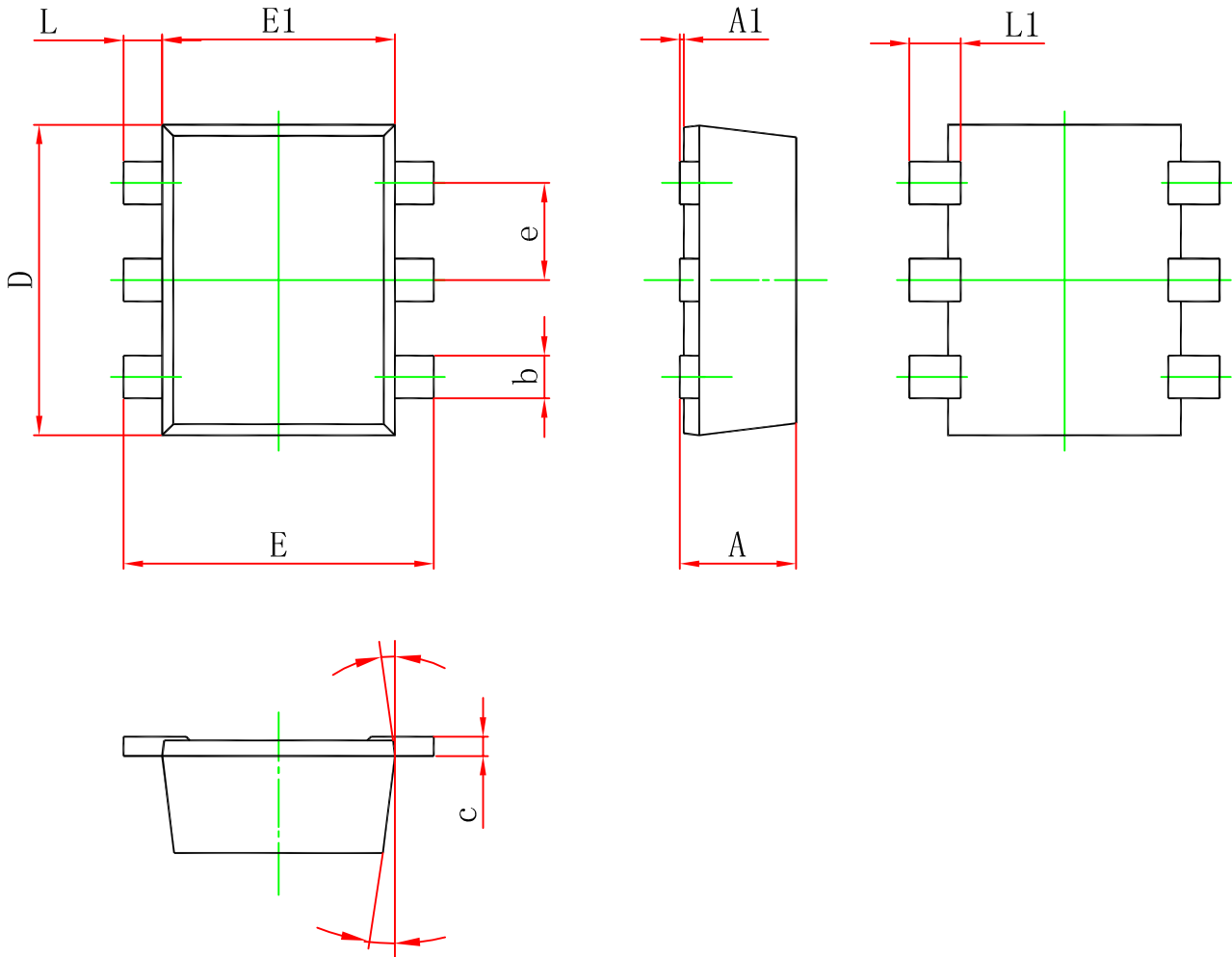
N-Channel Typical Characteristics



P-Channel Typical Characteristics



SOT-563 Package Information



Symbol	Dimensions In Millimeters		Dimensions in inches	
	Min.	Max.	Min.	Max.
A	0.525	0.600	0.021	0.024
A1	0.000	0.050	0.000	0.002
e	0.450	0.550	0.018	0.022
c	0.090	0.160	0.004	0.006
D	1.500	1.700	0.059	0.067
b	0.170	0.270	0.007	0.011
E1	1.100	1.300	0.043	0.051
E	1.500	1.700	0.059	0.067
L	0.100	0.300	0.004	0.012
L1	0.200	0.400	0.008	0.016
θ	7 °REF.		7 °REF.	